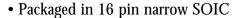
# ICS671-01 Zero Delay, Low Skew Buffer and Multipler

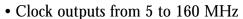
#### **Description**

The ICS671-01 is a low phase noise, high speed PLL based, 8 output, low skew zero delay buffer and multiplier. Based on ICS's proprietary low jitter Phase Locked Loop (PLL) techniques, the device provides eight low skew outputs at speeds up to 160 MHz at 3.3 V. The ICS671-01 includes a bank of six outputs running at either x2 or x4 mode, one output running at either x2, x4, or x5 mode, and one more output running at either x1, x2, or x4 mode. For normal operation, output clock CLK8 is tied to the FBIN pin.

ICS manufactures the largest variety of clock generators and buffers, and is the largest clock supplier in the world.

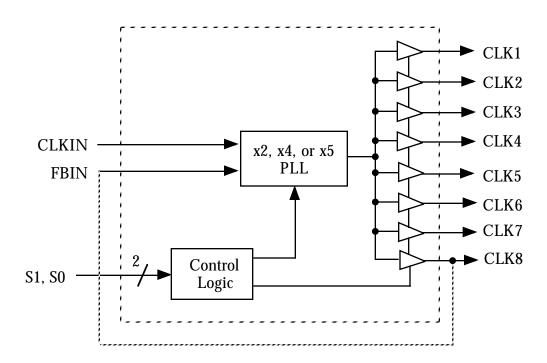
#### **Features**





- Zero input-output delay
- Integrated x2 or x4 selections, and x5 for CLK7
- Eight low-skew (<250 ps) outputs
- Full CMOS outputs with 25 mA output drive capability at TTL levels
- Tri-state mode for board-level testing
- Advanced, low power, sub-micron CMOS process
- 3.3 V to 5 V operating voltage

#### **Block Diagram**



#### Pin Assignment

ICS671-01

-			1
CLKIN 🗖	1	16	□ FBIN
CLK1 □	2	15	□ CLK8
CLK2 🗖	3	14	□ CLK7
VDD □	4	13	□VDD
GND□	5	12	□GND
CLK3 □	6	11	□ CLK6
CLK4 □	7	10	□ CLK5
S0 🗖	8	9	□ S1
_			

16 pin narrow (150 mil) SOIC

#### **Output Clock Mode Select Table**

	S1	S0	CLK1:6	CLK7	CLK8	Input range
	0	0	Tri-state (high impedance)	Tri-state (high impedance)	Tri-state (high impedance)	-
	0	1	x2	x5	x1	5 to 30 MHz
	1	0	x2	x2	x2	15 to 80 MHz
ſ	1	1	x4	x4	x4	7.5 to 40 MHz

#### **Pin Descriptions**

Number	Name	Туре	Description	
1	CLKIN	I	Clock Input.	
2, 3, 6, 7,				
10, 11	CLK1:6	0	Clock Outputs 1:6. See above table.	
4, 13	VDD	P	Power supply. Connect both pins to same voltage (either 3.3 V or 5 V).	
5, 12	GND	P	Connect to ground.	
8	S0	I	Select input 0. See table above.	
9	S1	I	Select input 1. See table above.	
14	CLK7	I	Clock Output 7. See table above.	
15	CLK8	I	Clock Output 8. See table above. Normally use this clock as feedback.	
16	FBIN	I	Feedback Input. Connect to CLK8 under normal operations.	

Key: I = Input; O = output; P = power supply connection.

#### **External Components**

The ICS671-01 requires a minimum number of external components for proper operation. Decoupling capacitors of  $0.01\mu F$  should be connected between VDD and GND on pins 4 and 5, and VDD and GND on pins 13 and 12, as close to the device as possible. A series termination resistor of 33  $\Omega$  may be used close to each clock output pin to reduce reflections.

MDS 671-01 B 2 Revision 051700 Printed 11/15/00



## ICS671-01 Zero Delay, Low Skew Buffer and Multipler

#### **Electrical Specifications**

Parameter	Conditions	Minimum	Typical	Maximum	Units
ABSOLUTE MAXIMUM RATINGS	(note 1)	-	•		
Supply voltage, VDD	Referenced to GND	-0.5		7	V
Inputs and Clock Outputs	Referenced to GND	-0.5		VDD+0.5	V
Electrostatic Discharge	MIL-STD-883	2000			V
Ambient Operating Temperature		0		70	°C
Soldering Temperature	Max of 10 seconds			260	°C
Junction temperature				150	°C
Storage temperature		-65		150	°C
DC CHARACTERISTICS (VDD = 3	3.3 V unless specified o	therwise)			
Operating Voltage, VDD		3.13		5.50	V
Input High Voltage, VIH, CLKIN pin only		VDD/2+1	VDD/2		V
Input Low Voltage, VIL, CLKIN pin only			VDD/2	VDD/2-1	V
Input High Voltage, VIH		2			V
Input Low Voltage, VIL				0.8	V
Output High Voltage, VOH	IOH=-25mA	2.4			V
Output Low Voltage, VOL	IOL=25mA			0.4	V
Output High Voltage, VOH, CMOS level	evel IOH=-8mA VDD-0.4			V	
Operating Suppl Current, IDD (Note 2)	No Load, S1=1, S0=0		25		mA
Operating Suppl Current, IDD (Note 3)	No Load, S1=1, S0=0		74		mA
Short Circuit Current	Each output		±50		mA
Input Capacitance	S0, S1, FBIN		7		pF
AC CHARACTERISTICS (VDD = 3	.3 V unless specified of	therwise)			
Input Clock Frequency	See table on page 2	5		80	MHz
Output Clock Frequency	See table on page 2	5		160	MHz
Output Clock Rise Time, CL=30pF	Time, CL=30pF 0.8 to 2.0V		1.5	ns	
Output Clock Fall Time, CL=30pF	2.0 to 0.8V		1.5	ns	
Output Clock Duty Cycle, VDD=3.3V	At VDD/2	At VDD/2 40 50 60		60	%
Device to Device Skew, equally loaded	rising edges at VDD/2 700		700	ps	
Output to Output Skew, equally loaded	r, equally loaded rising edges at VDD/2 250		250	ps	
Input to Output Skew, FBIN to CLK8	to Output Skew, FBIN to CLK8 rising edges at VDD/2 ±350		±350	ps	
Maximum Absolute Jitter			300		ps
Cycle to Cycle Jitter, 30pF loads				500	ps

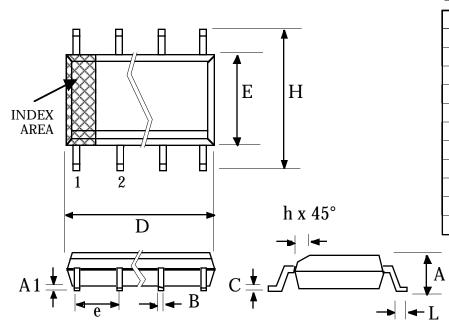
Notes:

- 1. Stresses beyond those listed under Absolute Maximum Ratings could cause permanent damage to the device. Prolonged exposure to levels above the operating limits but below the Absolute Maximums may affect device reliability.
- 2. With CLKIN = 20 MHz, FBIN to CLK8, all outputs at 40 MHz.
- 3. With CLKIN = 80 MHz, FBIN to CLK8, all outputs at 160 MHz.

## ICS671-01 Zero Delay, Low Skew Buffer and Multipler

### Package Outline and Package Dimensions

(For current dimensional specifications, see JEDEC Publication No. 95.)



#### 16 pin SOIC narrow

	Inch	ies	Millimeters		
Symbol	Min	Max	Min	Max	
Α	0.0532	0.0688	1.35	1.75	
A1	0.0040	0.0098	0.10	0.24	
В	0.0130	0.0200	0.33	0.51	
C	0.0075	0.0098	0.19	0.24	
D	0.3859	0.3937	9.80	10.00	
Е	0.1497	0.1574	3.80	4.00	
e	.050 BSC		1.27 B	SC	
Н	0.2284	0.2440	5.80	6.20	
h	0.0099	0.0195	0.25	0.50	
I.	0.0160	0.0500	0.41	1.27	

## **Ordering Information**

Part/Order Number	Marking	Shipping packaging	Package	Temperature
ICS671M-01	ICS671M-01	tubes	16 pin SOIC	0-70 °C
ICS671M-01T	ICS671M-01	tape and reel	16 pin SOIC	0-70 °C

While the information presented herein has been checked for both accuracy and reliability, Integrated Circuit Systems, Incorporated (ICS) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by ICS. ICS reserves the right to change any circuitry or specifications without notice. ICS does not authorize or warrant any ICS product for use in life support devices or critical medical instruments.

MDS 671-01 B 4 Revision 051700 Printed 11/15/00